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2018 16th Biennial Baltic Electronics Conference (BEC) Invited Talks

Prof. Dr. Marta Rencz – LED modelling for Industry 4.0 in the Delphi4LED project.

Dr. Daniel Foty – Amplification, Feedback, and Sub-Biasing: Applying Analog Techniques to High-Speed, Low-Power Digital CMOS Circuits at Dimensions Below 100nm.

Prof. Francois Verdier – Design of HW/SW SoCs by Using Models of Power and Clock Domains in SystemC-TLM.

Prof. Serge Dos Santos – Systemic multimodal technologies for entering in the NDT 4.0 transition: signal, image, and data for monitoring the health of biological, medical and industrial complex processes.

Prof. Ørjan Grøttem Martinsen – From linear to memristive electrical properties of human skin.

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³ Pakistan Institute of Engineering and Applied Sciences (PIEAS), Pakistan

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